Polymer

Wayon Electronics Co., Ltd.



LP-USML210

PTC Devices

No.1001, Shiwan 7th Road, Pudong, Shanghai 201202, P.R.China Tel: 86-21-50968308 Fax: 86-21-50968310

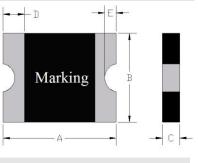
Surface Mount Thermistor E-mail: market@way-on.com

Fax: 86-21-50968310 *Http://www.way-on.com*

Features

- Small size 1210
- Low resistance
- Lead-free、Halogen-free and compliant with the European Union RoHS Directive (EU)2015/863
- Fast time-to-trip
- Agency Recognition: UL、TUV





Product Dimension (mm)

Part Number	А	В	С	D	E	
	Max.	Max.	Max.	Min.	Min.	
LP-USML210	3.43	2.80	0.80	0.25	0.10	

Electrical Characteristics

Dent Number	Ін	lτ	V _{max}	Imax	T _{trip}	0	Pd max	R _{min}	R _{1max}
Part Number	(A)	(A)	(V)	(A)	Current(A)	Time(S)	(W)	(Ω)	(Ω)
LP-USML210	2.10	4.20	6	50	8.0	5	1.2	0.004	0.026

 I_H =Hold current: maximum current at which the device will not trip at 25°C still air.

 I_T =Trip current: minimum current at which the device will always trip at 25°C still air.

V_{max}=Maximum voltage device can withstand without damage at rated current.

I_{max}=Maximum fault current device can withstand without damage at rated voltage.

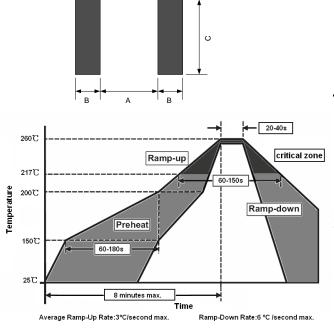
T_{trip}=Maximum time to trip(s) at assigned current.

Pd_{max}=Maximum power dissipation: typical amount of power dissipated by the device when in state air environment.

R_{min}=Minimum device resistance at 25°C prior to tripping.

R_{1max}=Maximum device resistance measured in the nontripped state 1 hour post reflow.

Solder Reflow Recommendation



Solder Pad Layout					
Dent Normhenn	Α	В	С		
Part Number —	(mm)	(mm)	(mm)		
LP-USML210	2.00	1.00	2.50		

* Recommended reflow methods: IR, vapor phase, hot air oven. **Notes:**

• If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

• Devices are not designed to be wave soldered to the bottom side of the board.

Package Information

Tape & Reel: 4000pcs per reel.

Effectivity: Reference documents shall be the issue in effect on the date of invitation for bid.

Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame.

	NT: M20042			
REV LETTER: D PAGE NO: 2 OF 2		Polymer	Marrie Electronico Os	UAYON
REV DATE: 2022-11-21		PTC Devices	Wayon Electronics Co., No 1001 Shiwan 7th Road Pl	Lτα. udong, Shanghai 201202, P.R.China
PART NUN			Tel: 86-21-50968308	Fax: 86-21-50968310
LP-US	ML210	Surface Mount Thermistor	E-mail: market@way-on.com	Http://www.way-on.com
		SN	AD PTC 使用注意事	项
			tions for SMD PTC	
1.	阻值升高,甚	至烧片。		大电流规格值的操作,可能会导致 PTC 出现电弧,
2.	规格书所规定 件下保持1小	的各温度下的 Hold current 均是 时。该电流并不是该型号 PTC f	PTC 经过一次回流焊接得能够适用的长期充电或放电	
	reflow welding long-term cha	g. PTC can hold 1 hour under cling or discharging current for	urrent conditions at a given this type of PTC.	nal performance of PTC obtained by one time n temperature. This current is not the condition of
3.	塑点胶等其他	热工序,会对上述参数有一定程	度的衰减。所以需要验证	
	generated pro at certain deg	cess like injection or dispensing ree. Therefore the verification to	g at the customer's premises to be conducted is nec	
4.		ermal sensitive device. It is rece		原元件,尽量减少外部热源的影响。 any heat source devices around it to reduce the
5.	PTC 贴片产品 度超过推荐的	是为 SMT 工艺设计的封装形式 值,PTC 将有可能受到损伤。 勢	禁止使用手工焊接 PTC, 勢	资工艺可参考维安推荐的回流焊曲线。如果回流焊温 处计线路板其他元件或端子返工时使用热风枪。 ng. Please refer to the Wayon recommended
6.	curve for refer Hand welding	ence. If the reflow soldering ter PTC is prohibited. Heat gun is	nperature exceeds the rec not allowed to use during	commended value, the PTC might be damaged. the circuit board components or terminals rework. 这粘剂、硅胶,需要对注塑料胶料等材料牌号以及应
0.	用参数(如温) When mountin	度、时间等)进行验证,以确保 ng or using PTC, all injection m	上产品及工艺的匹配性,确 [。] olding materials, curing ac	认不会影响 PTC 性能之后方可使用。 Ihesives, UV glue , silica gel and cleaning agents
7.	between the p	product and the processing befor	ore use.	perature, time, and etc to ensure the consistency 必须使用,需要验证各类清洗剂、洗板水以及溶剂
	的适用性,确 类等较强溶解 When mountin cleaning is red and confirm th to ethers, ben	认不会影响 PTC 性能之后方可作 性、破坏性的有机化合物。清洗 ng or using PTC, it is not recom quired, it is necessary to verify t nat they will not affect the PTC p zene homolog, ketones, lipids a	使用。已知对 PTC 有影响的 后将产品放置于敞开的环始 mended to use circuit boat the applicability of various performance . The known and derivates that is of s	的化学药品包括但不仅限于醚类、苯类、酮类以及脂 寬中至少 24 小时,将残留的溶剂进行充分的挥发。 ird washer water or other cleaning agent. If cleaning agents, washboard water and solvents, chemicals that impacts PTC include but not limited trong solubleness and ruinous. Please place the
8.	装配过程中, Please do not		l、刺等方式作用 PTC 本体	residuals. s,以免引起 PTC 性能衰减。 ng process otherwise it might be a cause of the
9.	月,则需密闭 When PTC is	,PTC 焊接至保护板后,如需注 保存,可避免 PTC 长时间暴露 welded to the PCM in product a	于空气环境中。 application, if injection or g	时间内完成,如贴装与注塑打胶时间间隔超过1个 luing is needed, it should be completed in as short
10.	environment t	sible. If the time slot between m o avoid long air exposure. 〔保护元件,但并不能当做开关创		uing surpasses 1 month,, please keep in airtight 低 PTC 的维持电流。
	PTC is resetta hold current.		all not be taken for use as	switch. Multiple times tripping shall lower the PTC
	In charging te material is inh	rminal application, PP type mat ibited.	erial is recommended to u	se as inner membrane and TPE and PVC type
12.	点的接触时间	不超过 3sec 。		m 以上,焊接工具温度低于 350°C,焊接铁头与焊 cess, it is suggested that the welding position shou
12	ld be more that between solde	an 1.5mm away from PTC, the ering iron and solder joint shoul	welding tool temperature s d not exceed 3sec.	should be lower than 350°C, and the contact time 现有包装破损的,立即将产品隔离处理,使用时如
13.	有余料, 需恢 Wayon low respackaging in s	复之前包装状态,做密封保存。 sistance SMD PTC humidity se stock, they should isolate the pr	nsitivity grade 2, for seale	d packaging. If customers find damaged e is surplus material, they need to restore the
14.	产品报废时, When the pro	tus , and do sealed storage. 可随着终端的产品,按照当地的 duct is finally discarded, it can b positions of PPTC can be referred	be treated recycled in acco	原材料组成可参见 MSDS。 ordance with local laws and regulations, and raw
15.	建议在设计保	护板时尽量使 PTC 远离精密电 nded to keep PTC away from p	沮和 MOS。	OS as much as possible when designing the